MA4P504-1072T



MELF PIN Diode 1 - 4000 MHz

M/A-COM Products Rev. V1

Features

- High Power Handling
- Low Loss / Low Distortion
- Low Thermal Resistance
- Leadless Low Inductance MELF Package
- Available as a Chip
- Surface Mountable
- **RoHs Compliant**
- MSL 1

Description

M/A-Com's MELF packaged PIN diode line encompasses a comprehensive range of electrical characteristics. The particular die in the MA4P504-1072T utilizes M/A-Com's unique CERMACHIP passivation process which provides for a hard glass encapsulation that hermetically seals the active area of the chip. This packaged CERMACHIP PIN diode is ideally suited for use in high power applications where high RF voltages are present.

The chip is enclosed in a rugged ceramic Metal Electrode Leadless Faced (MELF) surface mount package and is full face bonded to refractory metal pins on both the anode and cathode. The result is a low loss PIN diode with low thermal resistance due to symmetrical thermal paths. This rectangular PIN diode is designed for high volume tape and reel assembly. This user friendly package design provides for extremely easy automatic pick and place, indexing and assembly. All solderable surfaces are tin plated and compatible with industry standard reflow and vapor phase soldering processes.

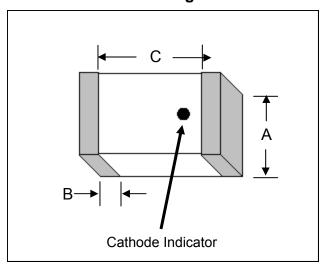
Applications

The MA4P504-1072T MELF packaged PIN diode is suitable for usage in high incident power series, shunt, or series-shunt switches as well as attenuator applications from HF through UHF frequencies.

Ordering Information

| Part Number | Package | |
|---------------|---------------|--|
| Ma4P504-1072T | Tape and Reel | |

Package Style (ODS 1072) Outline **Drawing**



| Dimensions | Package Style 1072 | | |
|------------|-----------------------|------|--|
| | in | mm | |
| А | 0.093 | 2.36 | |
| В | 0.050 | 1.27 | |
| С | 0.060 | 1.52 | |

Absolute Maximum Ratings^{1,2} @ 25°C

| Parameter | Absolute Maximum | | |
|-----------------------|-----------------------|--|--|
| Forward Voltage | 1.0 V | | |
| Reverse Voltage | 500V | | |
| Operating Temperature | -65°C to +175°C | | |
| Storage Temperature | -65°C to +200°C | | |
| Mounting Temperature | +260°C for 30 seconds | | |

- 1. Exceeding these limits may cause permanent damage to the
- 2. Values will derate over temperature.

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- North America Tel: 800.366.2266 / Fax: 978.366.2266
- Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298 Visit www.macom.com for additional data sheets and product information.

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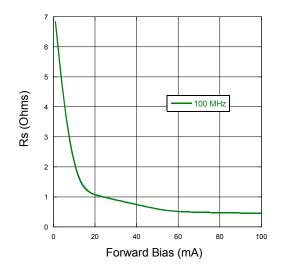
Electrical Specifications @ T_A = +25°C

| Parameters | Symbols | Conditions | Units | Min. | Тур. | Max. |
|--|--------------------|---|--------|------|------|------|
| Total Capacitance | C _{T100V} | -100 V @ 1 MHz | pF | _ | _ | 0.50 |
| Package Capacitance ¹ | C_p | _ | pF | | 0.16 | |
| Series Resistance | R _s | +100 mA @ 100 MHz | Ω | _ | _ | 0.60 |
| Minority Carrier Lifetime | T _L | $I_F = 10 \text{ mA}$ $I_R = -6 \text{ mA}$ | μS | _ | 1.0 | _ |
| Forward Voltage | V_{F} | + 50 mA | V | _ | _ | 1.0 |
| Reverse Leakage Current | -I _R | -500 V | μΑ | _ | _ | - 10 |
| Thermal Resistance | θ | _ | °C / W | _ | 15 | _ |
| Power Dissipation | Pd | _ | W | _ | _ | 10 |
| 3rd Order Input Intermodulation Distor- tion | IIP3 | +10dBm Input Power 1000 MHz 1 MHz Spacing | dBm | _ | >54 | _ |

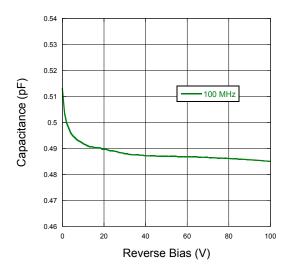
^{1.} Package capacitance is for the MELF-1072 package style. Total capacitance Ct = Junction Capacitance Cj + Package Capacitance Cp

Typical DC Performance Curves

Series Resistance vs. Forward Current



Capacitance vs. Reverse Voltage



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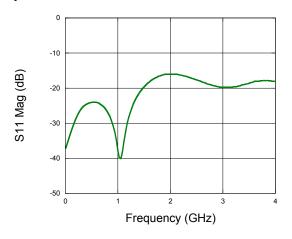
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APPLICATIONS SECTION

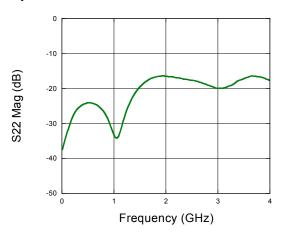
Typical RF Performance Curves (50 - 4000 MHz)

SERIES DIODE

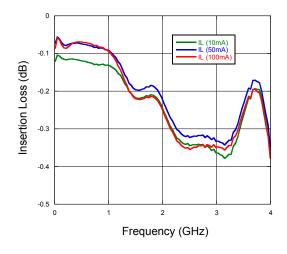
Input Return Loss



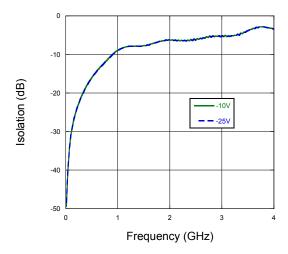
Output Return Loss



Insertion Loss



Isolation



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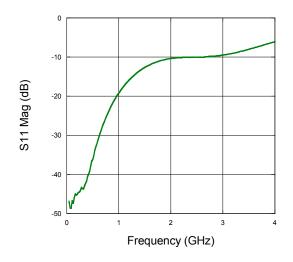
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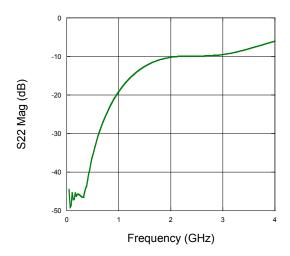
Typical RF Performance Curves (50 – 4000 MHz)

SHUNT DIODE

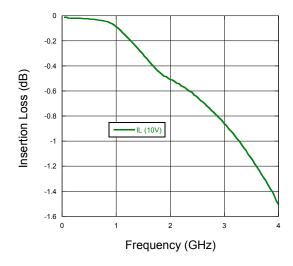
Input Return Loss



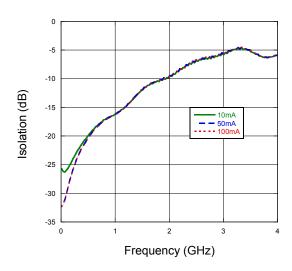
Output Return Loss



Insertion Loss



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Assembly Recommendations

- Devices may be soldered using standard 63/37, Sn/Pb or RoHS compliant solders. Leads are tin plated 50µM thick to ensure an optimum connection.
- For recommended Sn/Pb and RoHS soldering profile See Application Note <u>M538</u> on the M/A-COM website.

Handling Procedures

The following precautions should be observed to avoid damaging these devices.

Cleanliness and Storage

These devices should be handled and stored in a clean environment. Ends of the device are tin plated for greater solderability. Continuous exposure to high humidity (>80%) for extended periods may cause the surface to oxidize. Caution should be taken when storing devices for long periods.

ESD

These devices are susceptible to ESD and are rated Class 1C.

General Handling

Device can be handled with tweezers or vacuum pickups and are suitable for use with automatic pick-and-place equipment.

Note: To compare other MELF packaged diodes to the MA4P504-1072, please click on the link to an older version datasheet:

PACKAGED PIN DIODES

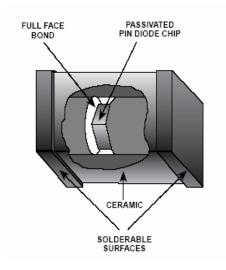
RoHS

The MA4P504-1072 is fully RoHS compliant meaning it contains less than the maximum allowable concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium.

Mounting Techniques

Solder Attach

Typical wave soldering or reflow techniques may be used to mount M/A-COM's SMQ packages to circuit boards using Sn63/Pb37 alloy or RoHS compliant solders. For more information visit the M/A-COM website and read application note M538.



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OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

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- Специальные условия для постоянных клиентов.
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- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
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- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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